

FSTU16862 20-Bit Bus Switch with -2V Undershoot Protection

General Description

The Fairchild Switch FSTU16862 provides 20-bits of high-speed CMOS TTL-compatible bus switching. The low On Resistance of the switch allows inputs to be connected to outputs without adding propagation delay or generating additional ground bounce noise.

The device is organized as a 20-bit bus switch. When \overline{OE}_X is LOW, the switch is ON and Port A is connected to Port B. When \overline{OE}_X is HIGH, a high impedance state exists between the A and B Ports. The A and B Ports are protected against undershoot to support an extended range to 2.0V below ground. Fairchild's integrated Undershoot Hardened Circuit (UHC™) senses undershoot at the I/O and responds by preventing voltage differentials from developing and turning the switch on.

Features

- Undershoot hardened to -2V (A and B Ports)
- 4Ω switch connection between two ports
- Minimal propagation delay through the switch
- Low I_{CC}
- Zero bounce in flow-through mode
- Control inputs compatible with TTL level
- See Application Note AN-5008 for details on FSTU - Undershoot Protected Fairchild Switch Family

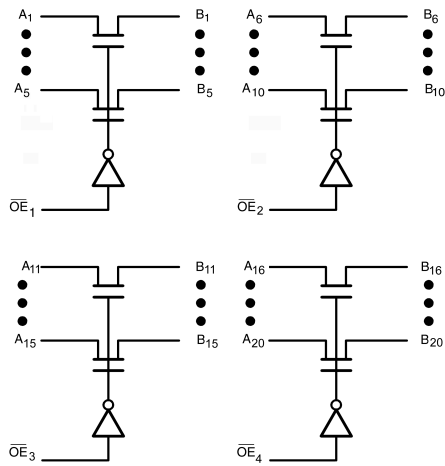
Ordering Code:

Order Number	Package Number	Package Description
FSTU16862QSP	MQA48A	48-Lead Quarter Size Very Small Outline Package (QVSOP), JEDEC MO-154, 0.150" Wide
FSTU16862MTD	MTD48	48-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 6.1mm Wide

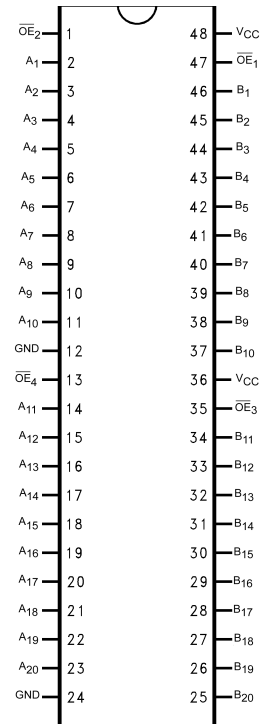
Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

UHC™ is a trademark of Fairchild Semiconductor Corporation.

Logic Diagram



Connection Diagram



Pin Descriptions

Pin Name	Description
\overline{OE}_x	Bus Switch Enables
A	Bus A
B	Bus B

Truth Table

Inputs	Inputs/Outputs
\overline{OE}_x	A, B
L	A = B
H	Z

H = HIGH Voltage Level
 L = LOW Voltage Level
 Z = High Impedance

Absolute Maximum Ratings(Note 1)

Supply Voltage (V_{CC})	-0.5V to +7.0V
DC Switch Voltage (V_S) (Note 2)	-2.0V to +7.0V
DC Input Voltage (V_{IN}) (Note 3)	-0.5V to +7.0V
DC Input Diode Current (I_{IK}) $V_{IN} < 0V$	-50 mA
DC Output Current (I_{OUT})	128 mA
DC V_{CC}/GND Current (I_{CC}/I_{GND})	± 100 mA
Storage Temperature Range (T_{STG})	-65°C to +150 °C

Recommended Operating Conditions (Note 4)

Power Supply Operating (V_{CC})	4.0V to 5.5V
Input Voltage (V_{IN})	0V to 5.5V
Output Voltage (V_{OUT})	0V to 5.5V
Input Rise and Fall Time (t_r, t_f)	
Switch Control Input	0 ns/V to 5 ns/V
Switch I/O	0 ns/V to DC
Free Air Operating Temperature (T_A)	-40 °C to +85 °C

Note 1: The "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the absolute maximum rating. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

Note 2: V_S is the voltage observed/applied at either the A or B Ports across the switch.

Note 3: The input and output negative voltage ratings may be exceeded if the input and output diode current ratings are observed.

Note 4: Unused control inputs must be held HIGH or LOW. They may not float.

DC Electrical Characteristics

Symbol	Parameter	V_{CC} (V)	$T_A = -40\text{ }^\circ\text{C to }+85\text{ }^\circ\text{C}$			Units	Conditions
			Min	Typ (Note 5)	Max		
V_{IK}	Clamp Diode Voltage	4.5			-1.2	V	$I_{IN} = -18\text{ mA}$
V_{IH}	HIGH Level Input Voltage	4.0-5.5	2.0			V	
V_{IL}	LOW Level Input Voltage	4.0-5.5			0.8	V	
I_I	Input Leakage Current	5.5			± 1.0	μA	$0 \leq V_{IN} \leq 5.5V$
		0			10	μA	$V_{IN} = 5.5V$
I_{OZ}	OFF-STATE Leakage Current	5.5			± 1.0	μA	$0 \leq A, B \leq V_{CC}$
R_{ON}	Switch On Resistance (Note 6)	4.5		4	7	Ω	$V_{IN} = 0V, I_{IN} = 64\text{ mA}$
		4.5		4	7	Ω	$V_{IN} = 0V, I_{IN} = 30\text{ mA}$
		4.5		8	14	Ω	$V_{IN} = 2.4V, I_{IN} = 15\text{ mA}$
		4.0		11	20	Ω	$V_{IN} = 2.4V, I_{IN} = 15\text{ mA}$
I_{CC}	Quiescent Supply Current	5.5			3	μA	$V_{IN} = V_{CC}$ or GND, $I_{OUT} = 0$
ΔI_{CC}	Increase in I_{CC} per Input (Note 7)	5.5			2.5	mA	One Input at 3.4V Other Inputs at V_{CC} or GND
V_{IKU}	Voltage Undershoot	5.5			-2.0	V	$0.0\text{ mA} \geq I_{IN} \geq -50\text{ mA}$ $\overline{OE} = 5.5V$

Note 5: Typical values are at $V_{CC} = 5.0V$ and $T_A = +25^\circ\text{C}$

Note 6: Measured by the voltage drop between A and B pins at the indicated current through the switch. On Resistance is determined by the lower of the voltages on the two (A or B) pins.

Note 7: Per TTL driven input, control pins only.

AC Electrical Characteristics

Symbol	Parameter	T _A = -40 °C to +85 °C, C _L = 50pF, R _U = R _D = 500Ω				Units	Conditions	Figure Number
		V _{CC} = 4.5 – 5.5V		V _{CC} = 4.0V				
		Min	Max	Min	Max			
t _{PHL} , t _{PLH}	Propagation Delay Bus-to-Bus (Note 8)		0.25		0.25	ns	V _I = OPEN	Figures 2, 3
t _{PZH} , t _{PZL}	Output Enable Time	1.0	5.9		6.4	ns	V _I = 7V for t _{PZL} V _I = OPEN for t _{PZH}	Figures 2, 3
t _{PHZ} , t _{PLZ}	Output Disable Time	1.0	6.9		7.4	ns	V _I = 7V for t _{PLZ} V _I = OPEN for t _{PHZ}	Figures 2, 3

Note 8: This parameter is guaranteed by design but is not tested. The bus switch contributes no propagation delay other than the RC delay of the typical On Resistance of the switch and the 50pF load capacitance, when driven by an ideal voltage source (zero output impedance).

Capacitance (Note 9)

Symbol	Parameter	Typ	Max	Units	Conditions
C _{IN}	Control Pin Input Capacitance	3		pF	V _{CC} = 5.0V, V _{IN} = 0V
C _{I/O}	Input/Output Capacitance "OFF State"	6		pF	V _{CC} , \overline{OE} = 5.0V, V _{IN} = 0V

Note 9: T_A = +25°C, f = 1 MHz, Capacitance is characterized but not tested.

Undershoot Characteristic (Note 10)

Symbol	Parameter	Min	Typ	Max	Units	Conditions
V _{OUTU}	Output Voltage During Undershoot	2.5	V _{OH} - 0.3		V	Figure 1

Note 10: This test is intended to characterize the device's protective capabilities by maintaining output signal integrity during an input transient voltage undershoot event.

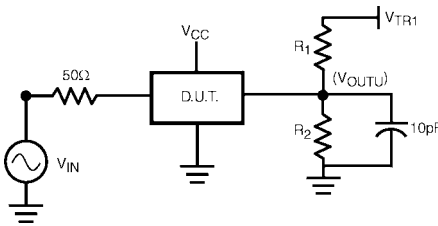
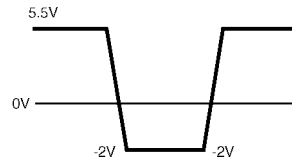


FIGURE 1.

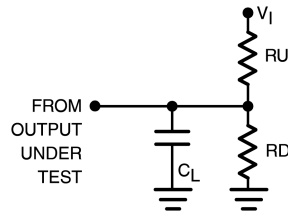
Device Test Conditions

Parameter	Value	Units
V _{IN}	see Waveform	V
R ₁ = R ₂	100K	Ω
V _{TR1}	11.0	V
V _{CC}	5.5	V

Transient Input Voltage (V_{IN}) Waveform



AC Loading and Waveforms



Note: Input driven by 50Ω source terminated in 50Ω

Note: C_L includes load and stray capacitance

Note: Input PRR = 1.0 MHz, $t_W = 500$ ns

FIGURE 2. AC Test Circuit

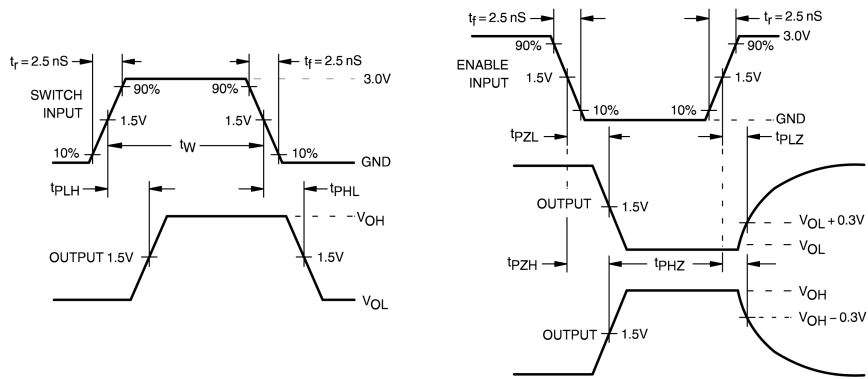
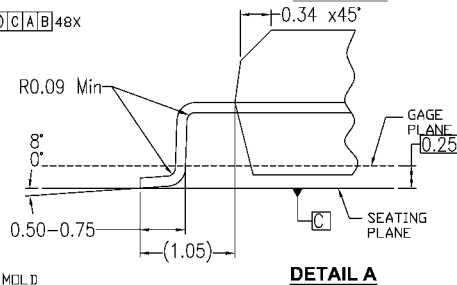
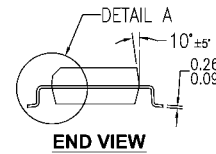
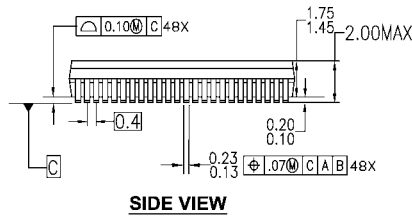
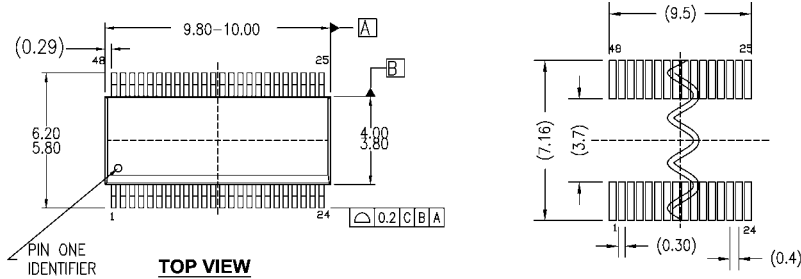


FIGURE 3. AC Waveforms

Physical Dimensions inches (millimeters) unless otherwise noted



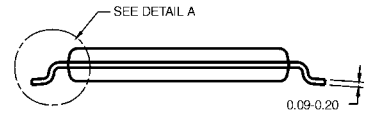
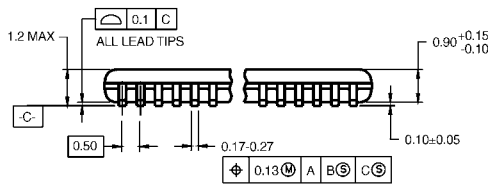
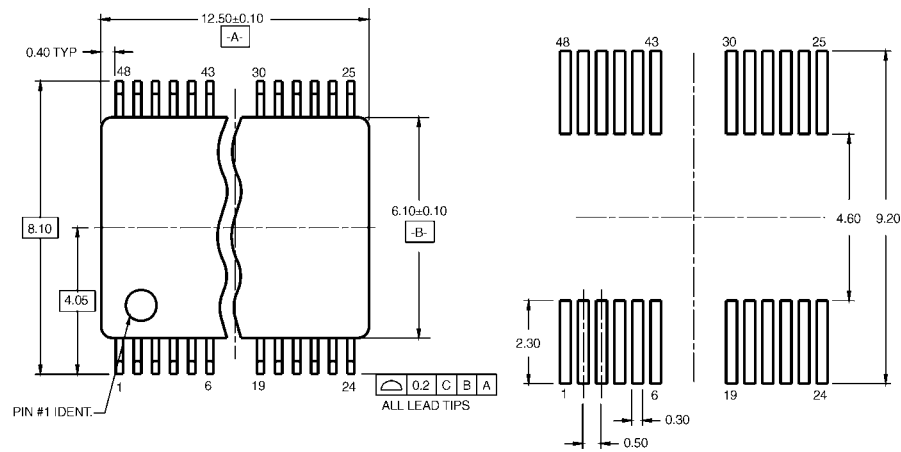
NOTES:

- A. THIS PACKAGE CONFORMS TO JEDEC MO-154 VERSION AB
- B. ALL DIMENSIONS IN MILLIMETERS
- C. DRAWING CONFORMS TO ASME Y14.5M-1994
- D. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.

MQA48AREVA

48-Lead Quarter Size Very Small Outline Package (QVSOP), JEDEC MO-154, 0.150" Wide Package Number MQA48A

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



DIMENSIONS ARE IN MILLIMETERS

- NOTES:
 A. CONFORMS TO JEDEC REGISTRATION MO-153, VARIATION AB, REF NOTE 6, DATE 7/93.
 B. DIMENSIONS ARE IN MILLIMETERS.
 C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
 D. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M, 1982.

MTD48RevB1

48-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 6.1mm Wide Package Number MTD48

Technology Description

The Fairchild Switch family derives from and embodies Fairchild's proven switch technology used for several years in its 74LVX3L384(FST3384) bus switch product.

Fairchild does not assume any responsibility for use of any circuitry described, no circuit patent licenses are implied and Fairchild reserves the right at any time without notice to change said circuitry and specifications.

LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF THE PRESIDENT OF FAIRCHILD SEMICONDUCTOR CORPORATION. As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury to the user.
2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

www.fairchildsemi.com